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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M4F
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, CSIO, EBI/EMI, I ² C, LINbus, SD, SPI, UART/USART, USB
Peripherals	DMA, I ² S, LVD, POR, PWM, WDT
Number of I/O	152
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 32x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	192-LFBGA
Supplier Device Package	192-FBGA (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/s6e2c58j0agb1000a

Base Timer (Max 16 Channels)

Operation mode is selected from the following for each channel:

- 16-bit PWM timer
- 16-bit PPG timer
- 16-/32-bit reload timer
- 16-/32-bit PWC timer

General Purpose I/O Port

This series can use its pins as general purpose I/O ports when they are not used for external bus or peripherals; moreover, the port relocate function is built in. It can set the I/O port to which the peripheral function can be allocated.

- Capable of pull-up control per pin
- Capable of reading pin level directly
- Built-in port-relocate function
- Up to 120 high-speed general-purpose I/O ports in 144 pin package
- Some pins 5V tolerant I/O.
See 4. Pin Descriptions and 5. I/O Circuit Type for the corresponding pins.

Multi-function Timer (Max three Units)

The multi-function timer is composed of the following blocks:

Minimum resolution: 5.00 ns

- 16-bit free-run timer × 3 ch/unit
- Input capture × 4 ch/unit
- Output compare × 6 ch/unit
- A/D activation compare × 6 ch/unit
- Waveform generator × 3 ch/unit
- 16-bit PPG timer × 3 ch/unit

The following functions can be used to achieve the motor control:

- PWM signal output function
- DC chopper waveform output function
- Dead time function
- Input capture function
- A/D convertor activate function
- DTIF (motor emergency stop) interrupt function

Real-Time Clock (RTC)

The real-time clock can count year, month, day, hour, minute, second, or day of the week from 00 to 99.

- Interrupt function with specifying date and time (year/month/day/hour/minute) is available. This function is also available by specifying only year, month, day, hour, or minute.
- Timer interrupt function after set time or each set time.
- Capable of rewriting the time with continuing the time count.
- Leap year automatic count is available.

Quadrature Position/Revolution Counter (QPRC; Max four Channels)

The Quadrature Position/Revolution Counter (QPRC) is used to measure the position of the position encoder. It is also possible to use up/down counter.

- The detection edge of the three external event input pins AIN, BIN and ZIN is configurable.
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers

Dual Timer (32-/16-bit Down Counter)

The dual timer consists of two programmable 32-/16-bit down counters.

Operation mode is selectable from the following for each channel:

- Free-running
- Periodic (= Reload)
- One shot

Watch Counter

The watch counter is used for wake up from low-power consumption mode. It is possible to select the main clock, sub clock, built-in High-speed CR clock, or built-in low-speed CR clock as the clock source.

- Interval timer: up to 64 s (max) with a sub clock of 32.768 kHz

External Interrupt Controller Unit

- External interrupt input pin: Max 32 pins
- Include one non-maskable interrupt (NMI)

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
Base Timer 0	TIOA0_0	Base Timer ch.0 TIOA Pin	56	46	38	N2
	TIOA0_1		45	35	30	J2
	TIOA0_2		114	94	78	L11
	TIOB0_0	Base Timer ch.0 TIOB Pin	82	67	57	L8
	TIOB0_1		21	-	-	-
	TIOB0_2		115	95	79	K13
Base Timer 1	TIOA1_0	Base Timer ch.1 TIOA Pin	57	47	39	N3
	TIOA1_1		46	36	31	K1
	TIOA1_2		116	96	80	K12
	TIOB1_0	Base Timer ch.1 TIOB Pin	83	68	58	K8
	TIOB1_1		22	-	-	-
	TIOB1_2		123	99	83	J13
Base Timer 2	TIOA2_0	Base Timer ch.2 TIOA Pin	58	48	40	M3
	TIOA2_1		47	37	32	K2
	TIOA2_2		124	100	84	J12
	TIOB2_0	Base Timer ch.2 TIOB Pin	84	69	59	J8
	TIOB2_1		26	-	-	-
	TIOB2_2		125	101	85	J11
Base Timer 3	TIOA3_0	Base Timer ch.3 TIOA Pin	59	49	41	L4
	TIOA3_1		48	38	33	K3
	TIOA3_2		130	106	86	H9
	TIOB3_0	Base Timer ch.3 TIOB Pin	91	76	60	K9
	TIOB3_1		27	-	-	-
	TIOB3_2		131	107	87	H12
Base Timer 4	TIOA4_0	Base Timer ch.4 TIOA Pin	60	50	42	M4
	TIOA4_1		49	39	34	K4
	TIOA4_2		132	108	88	H14
	TIOB4_0	Base Timer ch.4 TIOB Pin	92	77	61	P10
	TIOB4_1		28	-	-	-
	TIOB4_2		133	109	89	G14
Base Timer 5	TIOA5_0	Base Timer ch.5 TIOA Pin	61	51	43	N4
	TIOA5_1		50	40	35	L1
	TIOA5_2		134	110	90	H13
	TIOB5_0	Base Timer ch.5 TIOB Pin	93	78	62	N10
	TIOB5_1		29	-	-	-
	TIOB5_2		135	111	91	H11
Base Timer 6	TIOA6_0	Base Timer ch.6 TIOA Pin	179	147	117	D9
	TIOA6_1		85	70	-	N8
	TIOA6_2		200	-	-	-
	TIOB6_0	Base Timer ch.6 TIOB Pin	178	146	116	B8
	TIOB6_1		86	71	-	M8
	TIOB6_2		199	-	-	-

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
External Bus	MADATA00_0	External bus interface data bus (Address / data multiplex bus)	2	2	2	B2
	MADATA01_0		3	3	3	C2
	MADATA02_0		4	4	4	C3
	MADATA03_0		5	5	5	D5
	MADATA04_0		6	6	6	D2
	MADATA05_0		7	7	7	D1
	MADATA06_0		8	8	8	D3
	MADATA07_0		9	9	9	D4
	MADATA08_0		14	13	10	E5
	MADATA09_0		15	14	11	F1
	MADATA10_0		16	15	12	F2
	MADATA11_0		17	16	13	F3
	MADATA12_0		18	17	14	F4
	MADATA13_0		23	18	15	F5
	MADATA14_0		24	19	16	F6
	MADATA15_0		25	20	17	G2
	MADATA16_0		10	-	-	-
	MADATA17_0		11	-	-	-
	MADATA18_0		12	-	-	-
	MADATA19_0		13	-	-	-
	MADATA20_0		19	-	-	-
	MADATA21_0		20	-	-	-
	MADATA22_0		21	-	-	-
	MADATA23_0		22	-	-	-
	MADATA24_0		26	-	-	-
	MADATA25_0		27	-	-	-
	MADATA26_0		28	-	-	-
	MADATA27_0		29	-	-	-
	MADATA28_0	33	-	-	-	
	MADATA29_0	51	-	-	-	
	MADATA30_0	52	-	-	-	
	MADATA31_0	53	-	-	-	
	MDQM0_0	External bus interface byte mask signal output pin	30	21	18	G3
MDQM1_0	31		22	19	G4	
MDQM2_0	34		-	-	-	
MDQM3_0	35		-	-	-	
MALE_0	External bus interface Address Latch enable output signal for multiplex	211	171	139	C4	
MRDY_0	External bus interface external RDY input signal	80	65	55	L6	
MCLKOUT_0	External bus clock signal	32	23	20	G5	

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
Multi-function serial 3	SIN3_0	Multi-function serial interface ch.3 input pin	25	20	17	G2
	SIN3_1		56	46	38	N2
	SOT3_0 (SDA3_0)	Multi-function serial interface ch.3 output pin.	24	19	16	F6
	SOT3_1 (SDA3_1)	This pin operates as SOT3 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA3 when it is used in an I ² C (operation mode 4).	57	47	39	N3
	SCK3_0 (SCL3_0)	Multi-function serial interface ch.3 clock I/O pin.	23	18	15	F5
	SCK3_1 (SCL3_1)	This pin operates as SCK3 when it is used in a CSIO (operation modes 2) and as SCL3 when it is used in an I ² C (operation mode 4).	58	48	40	M3
Multi-function serial 4	SIN4_0	Multi-function serial interface ch.4 input pin	212	172	140	B3
	SIN4_1		193	161	131	D7
	SOT4_0 (SDA4_0)	Multi-function serial interface ch.4 output pin.	211	171	139	C4
	SOT4_1 (SDA4_1)	This pin operates as SOT4 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA4 when it is used in an I ² C (operation mode 4).	192	160	130	A6
	SCK4_0 (SCL4_0)	Multi-function serial interface ch.4 clock I/O pin.	210	170	138	B4
	SCK4_1 (SCL4_1)	This pin operates as SCK4 when it is used in a CSIO (operation modes 2) and as SCL4 when it is used in an I ² C (operation mode 4).	198	166	136	D6
	CTS4_0	Multi-function serial interface ch.4 CTS input pin	208	168	-	B5
	CTS4_1		197	165	135	C6
	RTS4_0	Multi-function serial interface ch.4 RTS output pin	209	169	137	C5
	RTS4_1		194	162	132	E7

List of Pin Behavior by Mode State

Pin Status Type	Function Group	Power-On Reset or Low-Voltage Detection State	INITX Input State	Device Internal Reset State	Run mode or Sleep mode State	Timer mode, RTC mode, or Stop mode State		Deep Standby RTC Mode or Deep Standby Stop mode State		Return From Deep Standby Mode State
		Power Supply Unstable	Power Supply Stable		Power Supply Stable	Power Supply Stable		Power Supply Stable		Power Supply Stable
		-	INITX=0	INITX=1	INITX=1	INITX=1		INITX=1		INITX=1
		-	-	-	-	SPL=0	SPL=1	SPL=0	SPL=1	-
A	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	Main crystal oscillator input pin/ external main clock input selected	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input Enabled
B	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	External main clock input selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	Maintain previous state	Hi-Z/internal input fixed at 0	Maintain previous State
	Main crystal oscillator output pin	Hi-Z/ internal input fixed at 0/ or input enable	Hi-Z/ internal input fixed at 0	Hi-Z/ internal input fixed at 0	Maintain previous state while oscillator active/ When oscillation stops*1, it will be Hi-Z/ Internal input fixed at 0					
C	INITX input pin	Pull-up/ input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled
D	Mode input pin	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled
E	Mode input pin	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled
	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/ input enabled	GPIO selected	Hi-Z/ input enabled	GPIO selected

Pin Status Type	Function Group	Power-On Reset or Low-Voltage Detection State	INITX Input State	Device Internal Reset State	Run mode or Sleep mode State	Timer mode, RTC mode, or Stop mode State		Deep Standby RTC Mode or Deep Standby Stop mode State		Return From Deep Standby Mode State	
		Power Supply Unstable	Power Supply Stable		Power Supply Stable	Power Supply Stable		Power Supply Stable		Power Supply Stable	
		-	INITX=0	INITX=1	INITX=1	INITX=1		INITX=1		INITX=1	
		-	-	-	-	SPL=0	SPL=1	SPL=0	SPL=1	-	
J	Analog output selected	Hi-Z	Hi-Z/ input enabled	Hi-Z/ input enabled	Maintain previous state	*2	*3	GPIO selected, internal input fixed at 0	Hi-Z/inter nal input fixed at 0	GPIO selected	
	External interrupt enable selected					Maintain previous state	Maintain previous state				
	Resource other than above selected						Hi-Z/inter nal input fixed at 0				
	GPIO selected						Hi-Z/inter nal input fixed at 0				
K	External interrupt enable selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Maintain previous state	GPIO selected, internal input fixed at 0	Hi-Z/inter nal input fixed at 0	GPIO selected	
	Resource other than above selected	Hi-Z	Hi-Z/ input enabled	Hi-Z/ input enabled			Hi-Z/inter nal input fixed at 0				
	GPIO selected						Hi-Z/inter nal input fixed at 0				
L	Analog input selected	Hi-Z	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	Hi-Z/ internal input fixed at 0/ analog input enabled	
	Resource other than above selected		Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/inter nal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/inter nal input fixed at 0	GPIO selected
	GPIO selected										

*8: The total average output current is defined as the average current value flowing through all of corresponding pins for a 100-ms period.

WARNING:

- *Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.*

Table 12-3 Typical and Maximum Current Consumption in Normal Operation(PLL), Code with Data Accessing Running from Flash Memory (Flash 0 Wait-cycle Mode and Read Access 0 Wait)

Parameter	Symbol	Pin Name	Conditions	Frequency* ⁴	Value		Unit	Remarks	
					Typ* ¹	Max* ²			
Power supply current	I _{CC}	V _{CC}	Normal operation * ⁶ ,* ⁷ (PLL)	* ⁵	72 MHz	71	161	mA	* ³ When all peripheral clocks are on
					60 MHz	62	150	mA	
					48 MHz	51	138	mA	
					36 MHz	40	125	mA	
					24 MHz	29	112	mA	
					12 MHz	17	98	mA	
					8 MHz	13	93	mA	
				4 MHz	8.4	88.5	mA		
				* ⁵	72 MHz	46	132	mA	* ³ When all peripheral clocks are off
					60 MHz	41	125	mA	
					48 MHz	34	118	mA	
					36 MHz	27	110	mA	
					24 MHz	20	102	mA	
					12 MHz	12	93	mA	
8 MHz	9.4	89.7	mA						
4 MHz	6.5	86.4	mA						

*1: T_A = +25°C, V_{CC} = 3.3 V

*2: T_J = +125°C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

*5: When operating flash 0 wait-cycle mode and read access 0 wait (FRWTR.RWT = 00, FBFCR.SD = 000)

*6: With data access to a MainFlash memory.

*7: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

12.4.8 Power-On Reset Timing

(V_{SS} = 0V)

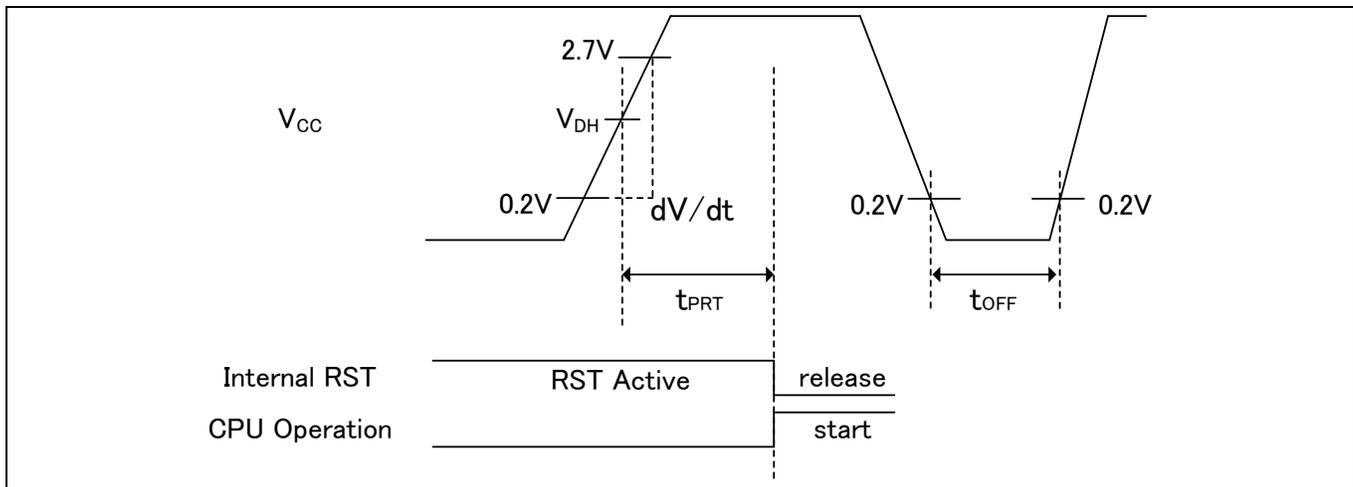
Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply shut down time	t _{OFF}	V _{CC}	-	1	-	-	ms	*1
Power ramp rate	dV/dt		V _{CC} : 0.2V to 2.70V	0.6	-	1000	mV/μs	*2
Time until releasing Power-on reset	t _{PRT}		-	0.33	-	0.60	ms	

*1: V_{CC} must be held below 0.2V for a minimum period of t_{OFF}. Improper initialization may occur if this condition is not met.

*2: This dV/dt characteristic is applied at the power-on of cold start (t_{OFF}>1ms).

Note:

- If t_{OFF} cannot be satisfied designs must assert external reset(INITX) at power-up and at any brownout event per 12. 4. 7.



Glossary

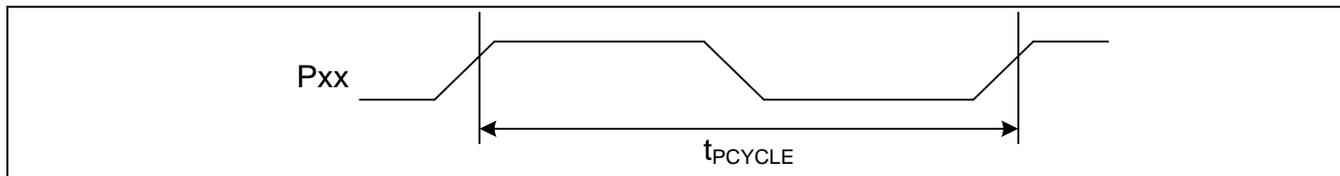
□ V_{DH}: detection voltage of Low Voltage detection reset. See “12.8. Low-Voltage Detection Characteristics”.

12.4.9 GPIO Output Characteristics

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Typ		
Output frequency	t _{PCYCLE}	Pxx*	V _{CC} ≥ 4.5 V	-	50	MHz	
			V _{CC} < 4.5 V	-	32	MHz	

*: GPIO is a target.



Separate Bus Access Asynchronous SRAM Mode

($V_{CC} = 2.7V$ to $5.5V$, $V_{SS} = 0V$)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
MOEX Minimum pulse width	$t_{OE\overline{W}}$	MOEX	-	$MCLK \times n - 3$	-	ns	
MCSX $\downarrow \rightarrow$ Address output delay time	$t_{CSL - AV}$	MCSX[7: 0], MAD[24: 0]	-	-9	+9	ns	
MOEX $\uparrow \rightarrow$ Address hold time	$t_{OE\overline{H} - AX}$	MOEX, MAD[24: 0]	-	0	$MCLK \times m + 9$	ns	
MCSX $\downarrow \rightarrow$ MOEX \downarrow delay time	$t_{CSL - OEL}$	MOEX, MCSX[7: 0]	-	$MCLK \times m - 9$	$MCLK \times m + 9$	ns	
MOEX $\uparrow \rightarrow$ MCSX \uparrow time	$t_{OE\overline{H} - CSH}$		-	0	$MCLK \times m + 9$	ns	
MCSX $\downarrow \rightarrow$ MDQM \downarrow delay time	$t_{CSL - RDQML}$	MCSX, MDQM[3: 0]	-	$MCLK \times m - 9$	$MCLK \times m + 9$	ns	
Data set up \rightarrow MOEX \uparrow time	$t_{DS - OE}$	MOEX, MADATA[31: 0]	-	20	-	ns	
MOEX $\uparrow \rightarrow$ Data hold time	$t_{DH - OE}$	MOEX, MADATA[31: 0]	-	0	-	ns	
MWEX Minimum pulse width	$t_{WE\overline{W}}$	MWEX	-	$MCLK \times n - 3$	-	ns	
MWEX $\uparrow \rightarrow$ Address output delay time	$t_{WE\overline{H} - AX}$	MWEX, MAD[24: 0]	-	0	$MCLK \times m + 9$	ns	
MCSX $\downarrow \rightarrow$ MWEX \downarrow delay time	$t_{CSL - WEL}$	MWEX, MCSX[7: 0]	-	$MCLK \times n - 9$	$MCLK \times n + 9$	ns	
MWEX $\uparrow \rightarrow$ MCSX \uparrow delay time	$t_{WE\overline{H} - CSH}$		-	0	$MCLK \times m + 9$	ns	
MCSX $\downarrow \rightarrow$ MDQM \downarrow delay time	$t_{CSL - WDQML}$	MCSX, MDQM[3: 0]	-	$MCLK \times n - 9$	$MCLK \times n + 9$	ns	
MCSX $\downarrow \rightarrow$ Data output time	$t_{CSL - DX}$	MCSX, MADATA[31: 0]	-	$MCLK - 9$	$MCLK + 9$	ns	
MWEX $\uparrow \rightarrow$ Data hold time	$t_{WE\overline{H} - DX}$	MWEX, MADATA[31: 0]	-	0	$MCLK \times m + 9$	ns	

Note:

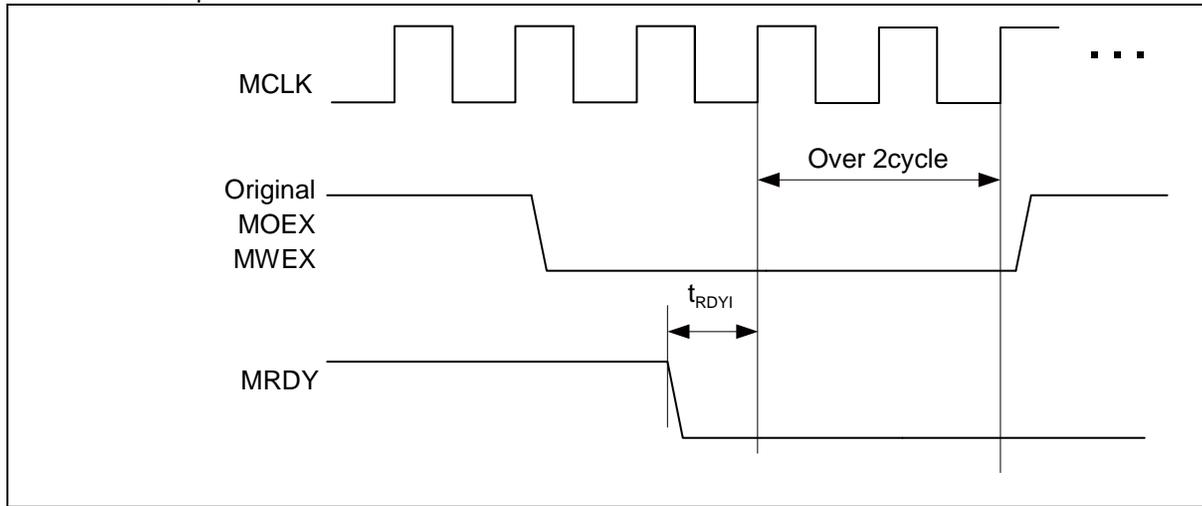
- When the external load capacitance $C_L = 30$ pF ($m = 0$ to 15 , $n = 1$ to 16)

External Ready Input Timing

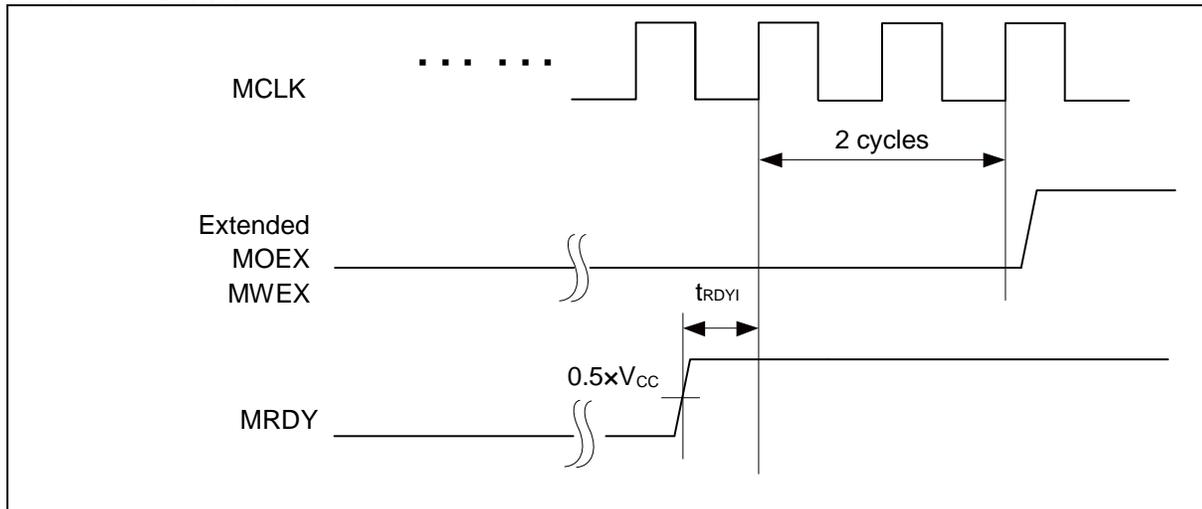
($V_{CC} = 2.7V$ to $5.5V$, $V_{SS} = 0V$)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
MCLK↑ MRDY input setup time	t_{RDYI}	MCLK, MRDY	-	19	-	ns	

■ When RDY is input



■ When RDY is released



When Using Synchronous Serial Chip Select (SCINV = 0, CSLVL = 1)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
			Min	Max	Min	Max	
SCS↓→SCK↓ setup time	t _{CSSI}	Internal shift clock operation	(*1)-50	(*1)+0	(*1)-50	(*1)+0	ns
SCK↑→SCS↑ hold time	t _{CShI}		(*2)+0	(*2)+50	(*2)+0	(*2)+50	ns
SCS deselect time	t _{CSDI}		(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	ns
SCS↓→SCK↓ setup time	t _{CSSe}	External shift clock operation	3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCK↑→SCS↑ hold time	t _{CShE}		0	-	0	-	ns
SCS deselect time	t _{CSDe}		3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCS ↓ →SOT delay time	t _{DSE}		-	40	-	40	ns
SCS ↑ →SOT delay time	t _{DSE}		0	-	0	-	ns

(*1): CSSU bit value × serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value × serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value × serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.

When Using Synchronous Serial Chip Select (SCINV = 0, CSLVL = 0)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
			Min	Max	Min	Max	
SCS↑→SCK↓ setup time	t _{CSSI}	Internal shift clock operation	(*1)-50	(*1)+0	(*1)-50	(*1)+0	ns
SCK↑→SCS↓ hold time	t _{CShI}		(*2)+0	(*2)+50	(*2)+0	(*2)+50	ns
SCS deselect time	t _{CSDI}		(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	ns
SCS↑→SCK↓ setup time	t _{CSE}	External shift clock operation	3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCK↑→SCS↓ hold time	t _{CSE}		0	-	0	-	ns
SCS deselect time	t _{CSE}		3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCS↑→SOT delay time	t _{DSE}		-	40	-	40	ns
SCS↓→SOT delay time	t _{DEE}		0	-	0	-	ns

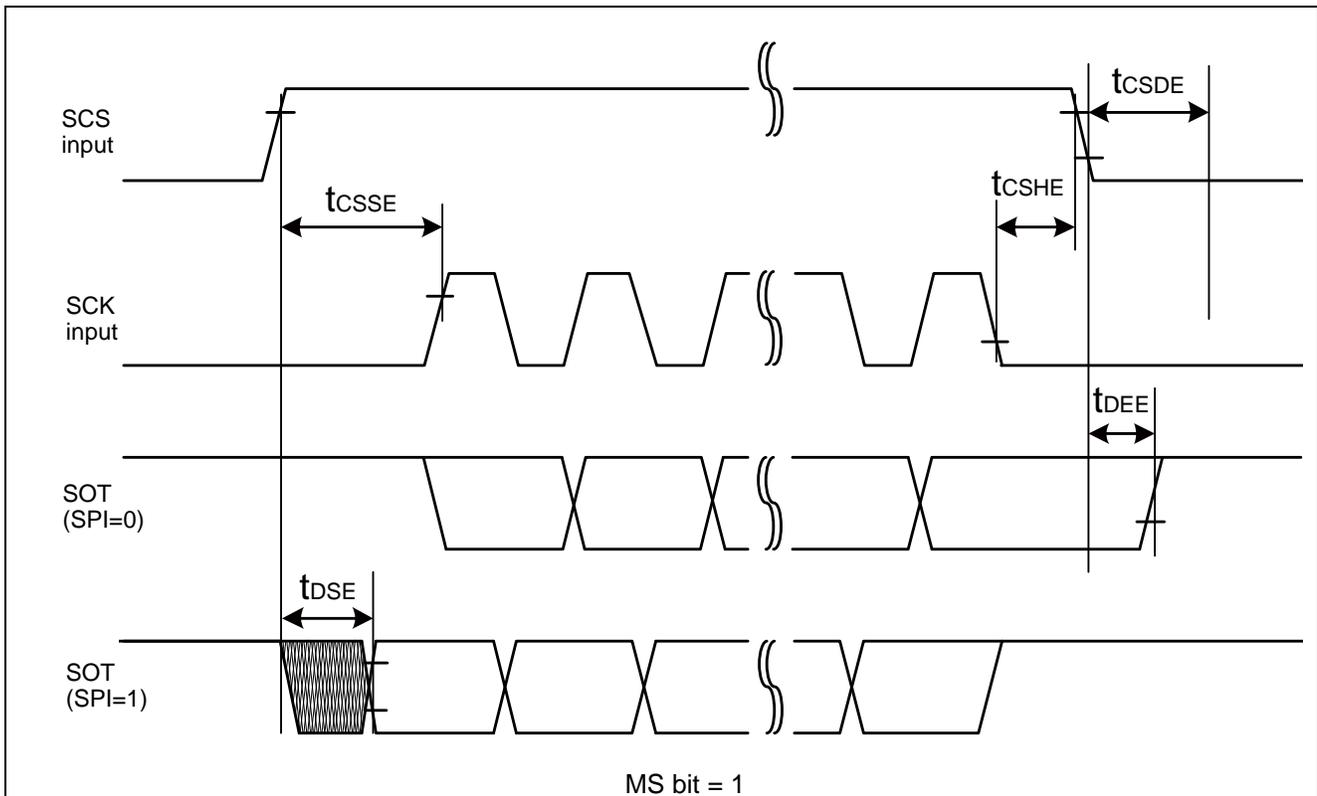
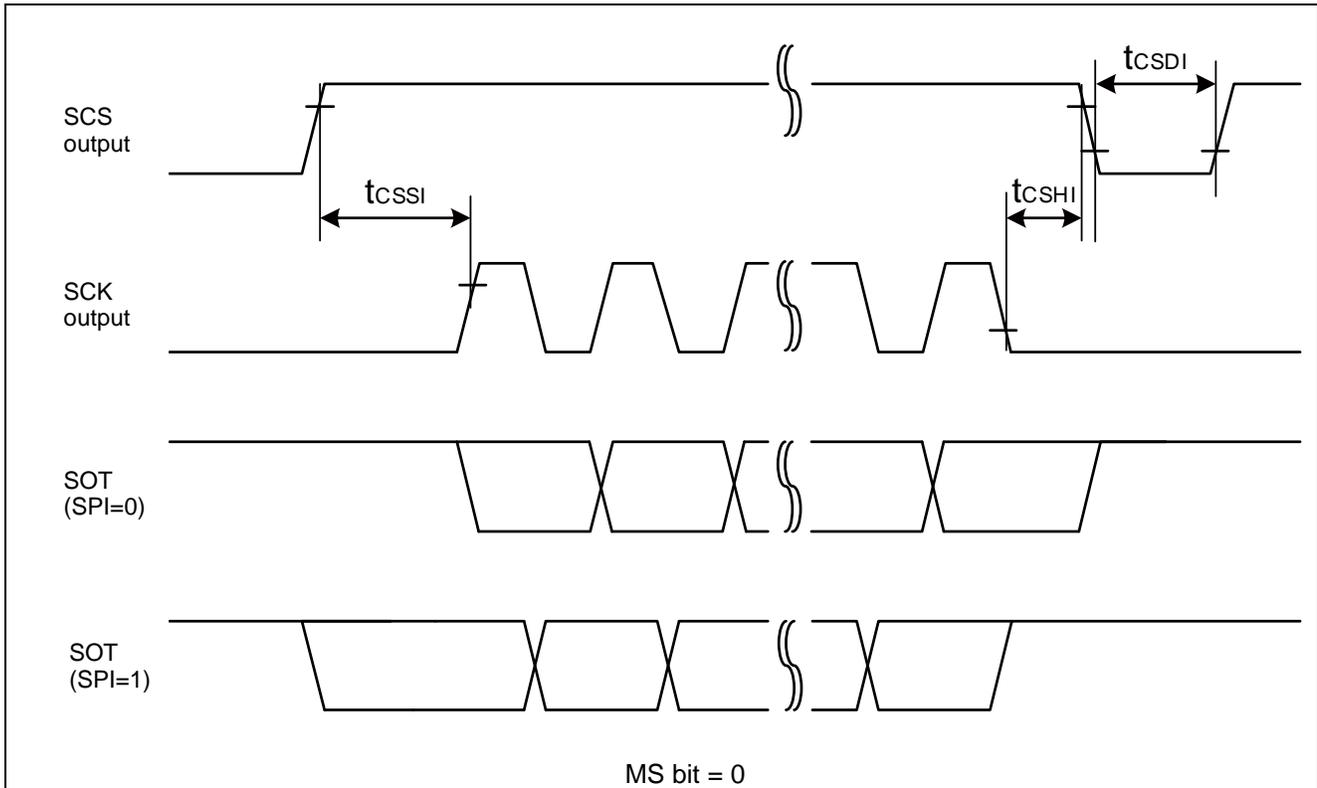
(*1): CSSU bit value × serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value × serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value × serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



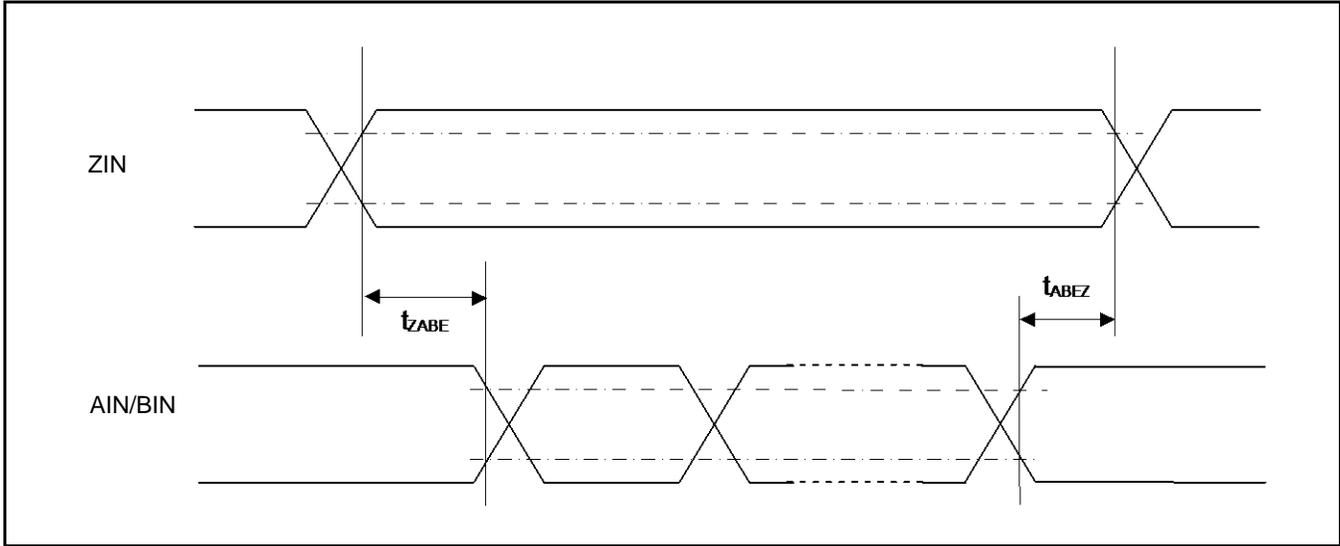
High-Speed Synchronous Serial (SPI = 1, SCINV = 0)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t _{SCYC}	SCKx	Internal shift clock operation	4t _{CYCP}	-	4t _{CYCP}	-	ns
SCK↑→SOT delay time	t _{SHOVI}	SCKx, SOTx		- 10	+ 10	- 10	+ 10	ns
SIN→SCK↓ setup time	t _{IVSLI}	SCKx, SINx		14	-	12.5	-	ns
				12.5*				
SCK↓→SIN hold time	t _{SLIXI}	SCKx, SINx		5	-	5	-	ns
SOT→SCK↓ delay time	t _{SOVLI}	SCKx, SOTx		2t _{CYCP} - 10	-	2t _{CYCP} - 10	-	ns
Serial clock L pulse width	t _{LSLH}	SCKx	External shift clock operation	2t _{CYCP} - 5	-	2t _{CYCP} - 5	-	ns
Serial clock H pulse width	t _{SHSL}	SCKx		t _{CYCP} + 10	-	t _{CYCP} + 10	-	ns
SCK↑→SOT delay time	t _{SHOVE}	SCKx, SOTx		-	15	-	15	ns
SIN→SCK↓ setup time	t _{IVSLE}	SCKx, SINx		5	-	5	-	ns
SCK↓→SIN hold time	t _{SLIXE}	SCKx, SINx		5	-	5	-	ns
SCK fall time	t _F	SCKx		-	5	-	5	ns
SCK rise time	t _R	SCKx		-	5	-	5	ns

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 No chip select: SIN4_0, SOT4_0, SCK4_0
 Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (for *, when C_L = 10 pF)



12.5 12-bit A/D Converter

Electrical Characteristics for the A/D Converter

($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = AV_{RL} = 0V$)

Parameter	Symbol	Pin Name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	-	-	-	-	12	bit	
Integral nonlinearity	-	-	- 4.5	-	+ 4.5	LSB	AVRH = 2.7 V to 5.5 V
Differential nonlinearity	-	-	- 2.5	-	+ 2.5	LSB	
Zero transition voltage	V _{ZT}	ANxx	- 15	-	+ 15	mV	
Full-scale transition voltage	V _{FST}	ANxx	AVRH - 15	-	AVRH + 15	mV	
			AV _{CC} - 15	-	AV _{CC} + 15	mV	
Conversion time	-	-	0.5 ^{*1}	-	-	μs	AV _{CC} ≥ 4.5 V
Sampling time *2	t _s	-	0.15	-	10	μs	AV _{CC} ≥ 4.5 V
			0.3	-			AV _{CC} < 4.5 V
Compare clock cycle *3	t _{CK}	-	25	-	1000	ns	AV _{CC} ≥ 4.5 V
			50	-	1000		AV _{CC} < 4.5 V
State transition time to operation permission	t _{STT}	-	-	-	1.0	μs	
Power supply current (analog + digital)	-	AV _{CC}	-	0.69	0.92	mA	A/D 1 unit operation
			-	1.3	22	μA	When A/D stop
Reference power supply current (AVRH)	-	AVRH	-	1.1	1.97	mA	A/D 1 unit operation AVRH = 5.5 V
			-	0.3	6.3	μA	When A/D stop
Analog input capacity	C _{AIN}	-	-	-	12.05	pF	
Analog input resistance	R _{AIN}	-	-	-	1.2	kΩ	AV _{CC} ≥ 4.5 V
					1.8		AV _{CC} < 4.5 V
Interchannel disparity	-	-	-	-	4	LSB	
Analog port input leak current	-	ANxx	-	-	5	μA	
Analog input voltage	-	ANxx	AV _{SS}	-	AVRH	V	
			AV _{SS}	-	AV _{CC}	V	
Reference voltage	-	AVRH	4.5	-	AV _{CC}	V	T _{CK} < 50 ns
			2.7	-	AV _{CC}		T _{CK} ≥ 50 ns
	-	AVRL	AV _{SS}	-	AV _{SS}	V	

*1: The conversion time is the value of sampling time (T_s) + compare time (T_c).

The condition of the minimum conversion time is when the value of T_s = 150 ns and T_c = 350 ns (AV_{CC} ≥ 4.5V). Ensure that it satisfies the value of sampling time (T_s) and compare clock cycle (T_{CK}). For setting of sampling time and compare clock cycle, see Chapter 1-1: A/D Converter in FM4 Family Peripheral Manual Analog Macro Part (002-04860). The register setting of the A/D converter is reflected by the APB bus clock timing. For more information about the APB bus number to which the A/D converter is connected, see 8. Block Diagram in this data sheet.

The sampling and compare clock are set at base clock (HCLK).

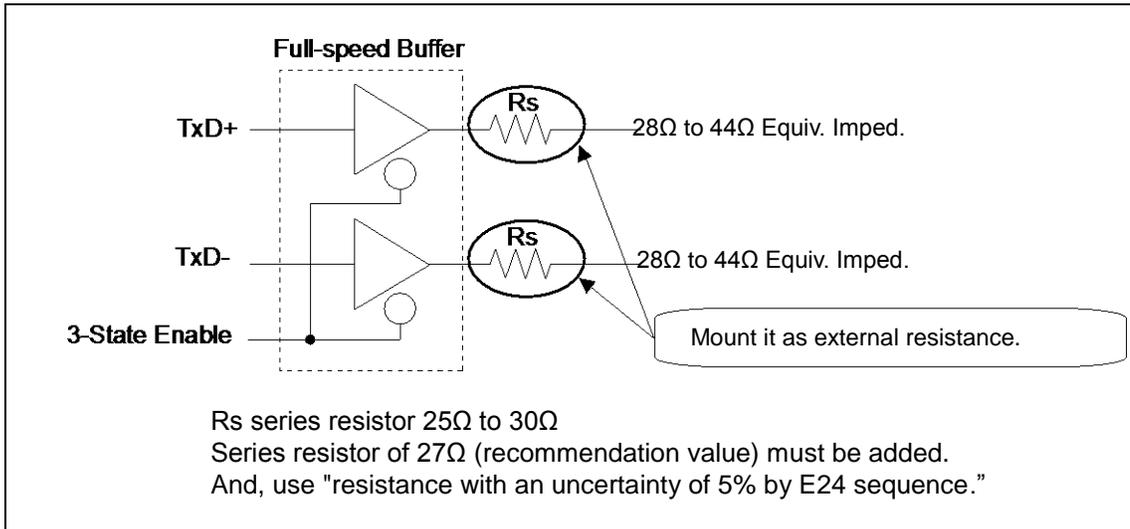
*2: A necessary sampling time changes by external impedance. Ensure that it sets the sampling time to satisfy (Equation 1).

*3: The compare time (T_c) is the value of (Equation 2).

*6: USB Full-speed connection is performed via twisted-pair cable shield with $90 \Omega \pm 15\%$ characteristic impedance (differential mode).

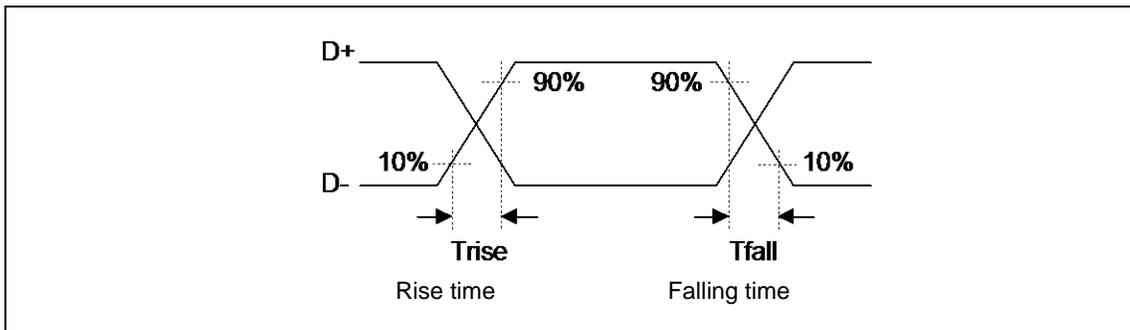
USB standard defines that the output impedance of the USB driver must be in the range from 28Ω to 44Ω . So, a discrete series resistor (R_s) addition is defined in order to satisfy the above definition and keep balance.

When using this USB I/O, use it with 25Ω to 30Ω (recommended value 27Ω) series resistor R_s .



*7: They indicate rise time (T_{rise}) and fall time (T_{fall}) of the low-speed differential data signal.

They are defined by the time between 10% and 90% of the output signal voltage.

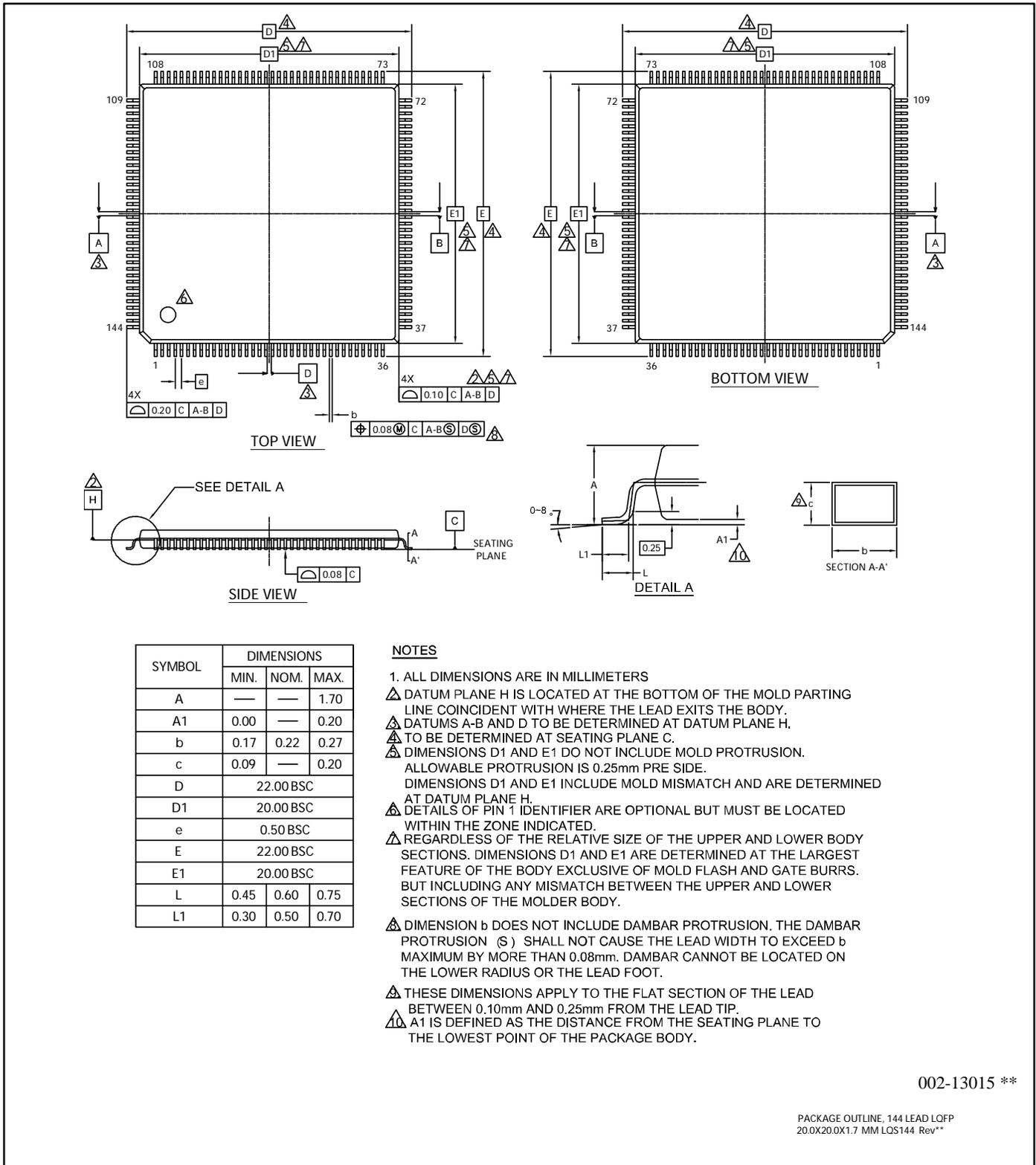


Note:

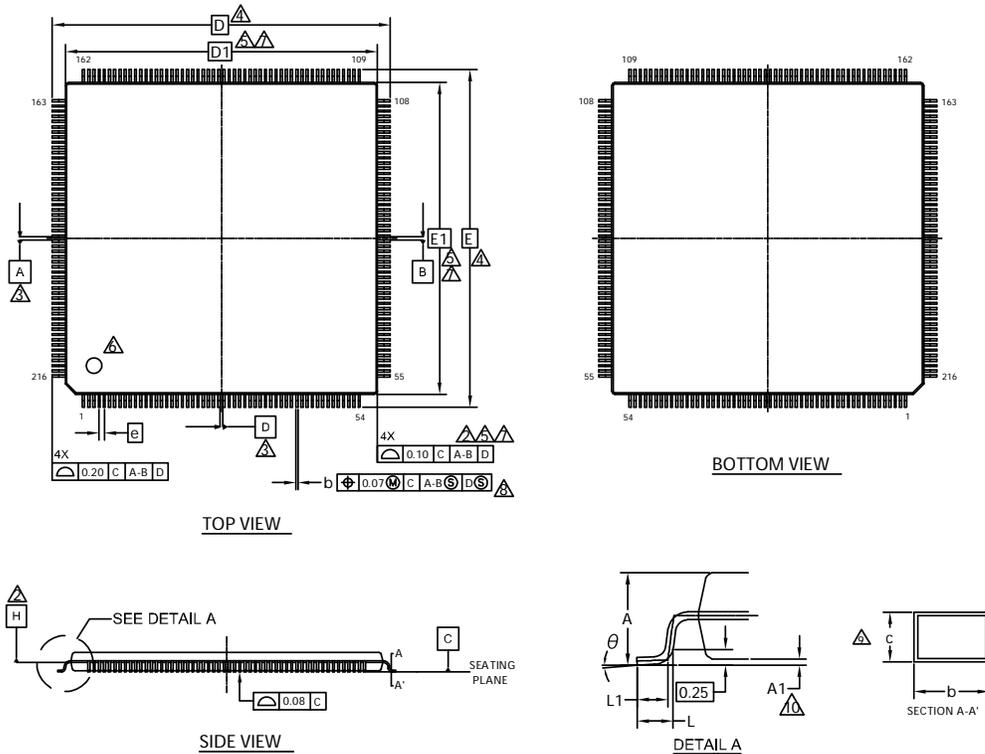
- See Low-Speed Load (Compliance Load) for conditions of external load.

14. Package Dimensions

Package Type	Package Code
LQFP 144	LQS 144



Package Type	Package Code
LQFP 216	LQQ 216



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.13	0.18	0.23
c	0.09	—	0.20
D	26.00 BSC.		
D1	24.00 BSC.		
e	0.40 BSC.		
E	26.00 BSC.		
E1	24.00 BSC.		
L	0.45	0.60	0.75
L1	0.30	0.50	0.70
θ	0°	—	8°

NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS, DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBER PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-15153 **

PACKAGE OUTLINE, 216 LEAD LQFP
24.0X24.0X1.7 MM LQQ216 REV**